

650V, 380mΩ, 11.2 A Super Junction Power MOSFET

Ordering Information

Part Number	Package Option
D3S380N65B-U	TO-220
D3S380N65E-T	TO-263
D3S380N65F-U	TO-220 FullPak (FP)

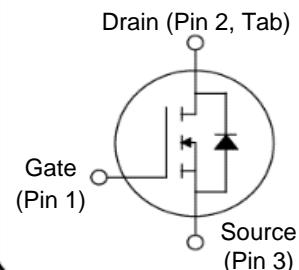


Description

+FET™ is an advanced Super Junction Power MOSFET offering excellent efficiency through low R_{DS(ON)} and low gate charge.

+FET™ is a rugged device with precision charge balance implementation designed for demanding uses such as enterprise power computing power supplies, motor control, lighting and other challenging power conversion applications.

Device Schematic



Features

- LOW R_{DS(ON)}
- FAST SWITCHING
- HIGH E_{AS}
- REL TEST SPEC: JESD-22
- LOW OUTPUT CAPACITANCE

Benefits

- LOW CONDUCTION LOSSES
- HIGH EFFICIENCY
- EXCELLENT AVALANCHE PERFORMANCE

Table 1 Key Performance Parameters

Parameters	Value	Unit
V _{DS} @ T _J max	710	V
RDS(on),max	<380	mΩ
Q _g ,typ	16	nC
I _D @ 25C	11.2	A
C _{oss}	35	pf

Applications

- POWER FACTOR CORRECTION
- SERVER POWER SUPPLIES
- TELECOM POWER SUPPLIES
- INVERTERS
- MOTOR CONTROL

Table of contents

Description-----	1
Maximum ratings-----	3
Thermal characteristics-----	3
Electrical characteristic-----	4
Electrical characteristics diagrams-----	6
Test Circuit & Waveform-----	11
Revision-----	16

@ T_J = 25°C ,unless otherwise specified

Table 2 Maximum ratings

Parameter	Symbol	Values				Unit	Note/Test Condition		
		Min.	Typ.	Max.					
				220, 263 &247	220FP				
Continuous drain current(1)	I _D			11.2	7.0	A	T _C = 25°C		
				7.1	4.4		T _C = 100°C		
Pulsed drain current(2)	I _{D,pulse}			44.7	28.0	A	T _C = 25°C		
Avalanche energy, single pulse	E _{AS}			202	202	mJ	I _D =1.8A, V _{DD} =50V		
Avalanche energy, repetitive	E _{AR}			0.5	0.5	mJ	I _D =1.8A, V _{DD} =50V		
Avalanche current, repetitive	I _{AR}			1.8	1.8	A			
MOSFET dv/dt ruggedness	dv/dt			50	50	V/ns	V _{DS} =...480V		
Gate source voltage	V _{GS}	-30		30	30	V	static		
		-30		30	30		AC (f > 1HZ)		
Power dissipation for TO-220	P _{tot}			114	44	W	T _C = 25°C		
Operating and storage temperature	T _j , T _{stg}	-55		150	150	°C			
Mounting torque				60		Ncm	M3 and M3.5 screws		
					50		M3 screws		
Continuous diode forward current	I _S			11.2	7.0	A	T _C = 25°C		
Diode pulsed current	I _{S,pulse}			44.7	28.0	A	T _C = 25°C		
Reverse diode dv/dt(3)	dv/dt			15	15	V/ns	V _{DS} =...480V, I _{SD} <I _D T _J = 25°C		
Maximum diode commutation speed	dif/dt			500	500	A/us			

Table 3 Thermal characteristics

Parameter	Symbol	Values				Unit	Note/Test Condition		
		Min.	Typ.	Max.					
				220, 263 &247	220FP				
Thermal resistance, Junction-case	R _{thJC}			1.3	3.1	°C/W			
Thermal resistance, Junction-ambient	R _{thJA}			55.8	60	°C/W	Leaded		
Soldering temperature, wavesoldering only allowed at leads	T _{sold}			260	260	°C	1.6mm form case for 10s		

Table 4 Static characteristics

Parameter	Symbol	Values			Unit	Note/Test Condition
		Min.	Typ.	Max.		
Drain to source breakdown voltage	$V_{(BR)DSS}$	650			V	$V_{GS}=0V, I_D=1mA$
Gate threshold voltage	$V_{GS(TH)}$	2.3	3.2	4.5	V	$V_{DS}=V_{GS}, I_D=52.6\mu A$
Zero gate voltage drain current	I_{DSS}			1	uA	$V_{DS}=650V, V_{GS}=0V, T_J = 25^\circ C$
				40		$V_{DS}=650V, V_{GS}=0V, T_J = 150^\circ C$
Gate to source leakage current	I_{GSS}			100	nA	$V_{GS}=\pm 20V, V_{DS}=0V$
Drain-source on-state resistance	$R_{DS(On)}$		320	380	mΩ	$V_{GS}=10V, I_D=5.6A, T_J = 25^\circ C$
			860		mΩ	$V_{GS}=10V, I_D=5.6A, T_J = 150^\circ C$
Gate resistance	R_G		1.1		Ω	Scaf-F

Table 5 Dynamic characteristics

Parameter	Symbol	Values			Unit	Note/Test Condition
		Min.	Typ.	Max.		
Input capacitance	C_{iss}		618		pF	$V_{GS}=0V, V_{DS}=100V, f=1MHz$
Output capacitance	C_{oss}		26.2		pF	
Reverse transfer capacitance	C_{rss}		4.8		pF	
Effective output capacitance, energy related 1	$C_{o(er)}$		63		pF	
Effective output capacitance, time related 2	$C_{o(tr)}$		137		pF	
Turn on delay time	$t_{d(on)}$		5		ns	
Rising time	t_r		21		ns	
Turn off delay time	$t_{d(off)}$		20		ns	
Fall time	t_f		24		ns	

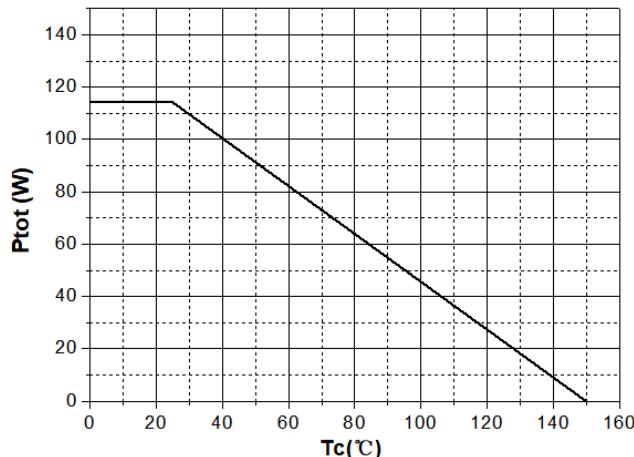
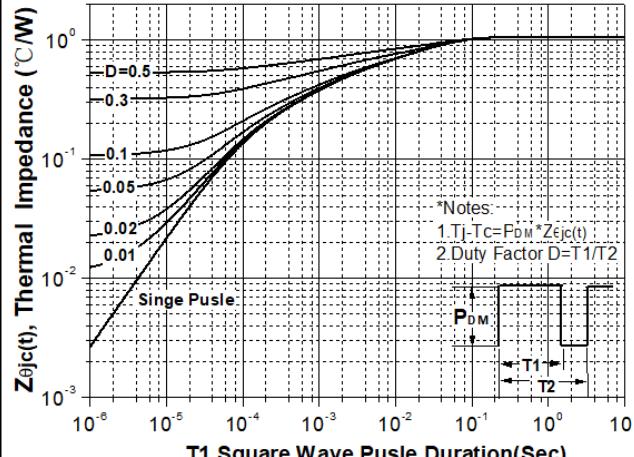
Table 6 Gate charge characteristics

Parameter	Symbol	Values			Unit	Note/Test Condition
		Min.	Typ.	Max.		
Total gate charge	Q_g		15.4		nC	$V_{DD}=480V, V_{GS}=0 \text{ to } 10V$ $I_D=5.6A$
Gate-source charge	Q_{gs}		4.1		nC	
Gate-drain charge	Q_{gd}		6.2		nC	
Gate plateau voltage	$V_{plateau}$		5.0		V	

Table 7 Reverse diode characteristics

Parameter	Symbol	Values			Unit	Note/Test Condition
		Min.	Typ.	Max.		
Diode forward voltage	V_{SD}		0.84	0.96	V	$I_F=11.2A, V_{GS}=0V, T_J = 25^\circ C$
Reverse recovery time	t_{rr}		232		ns	
Reverse recovery charge	Q_{rr}		2.0		uC	
Peak reverse recovery current	I_{rrm}		16.6		A	

Table 8 Thermal Performance

Power dissipation (TO220, TO263 & TO247)	Max. transient thermal impedance (TO220, TO263 & TO247)
	
$P_{\text{tot}}=f(T_c)$	$Z_{\text{thJC}}=f(t_p)$; parameter: $D=t_p/T$

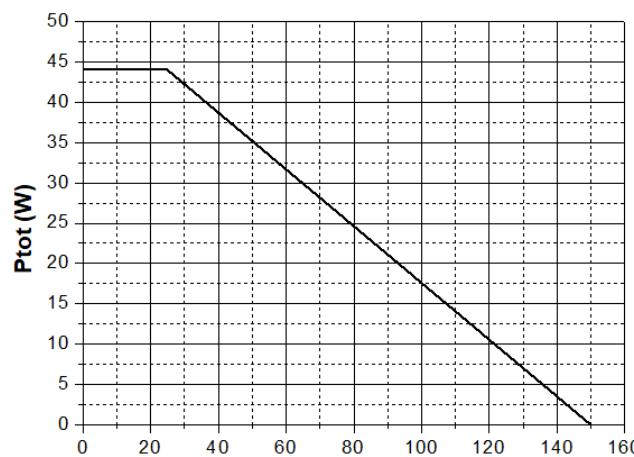
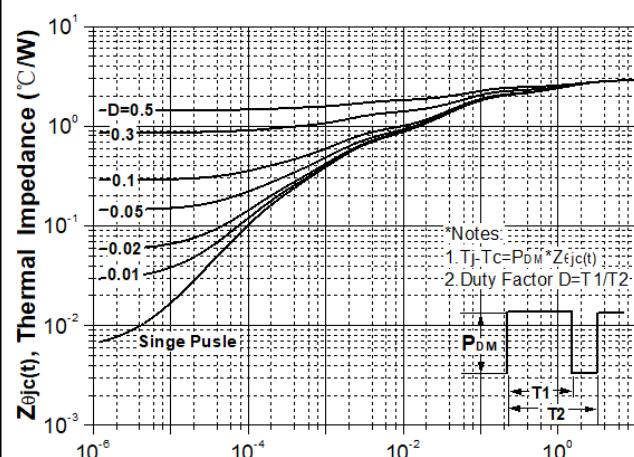
Power dissipation (TO220F)	Max. transient thermal impedance (TO220F)
	
$P_{\text{tot}}=f(T_c)$	$Z_{\text{thJC}}=f(t_p)$; parameter: $D=t_p/T$

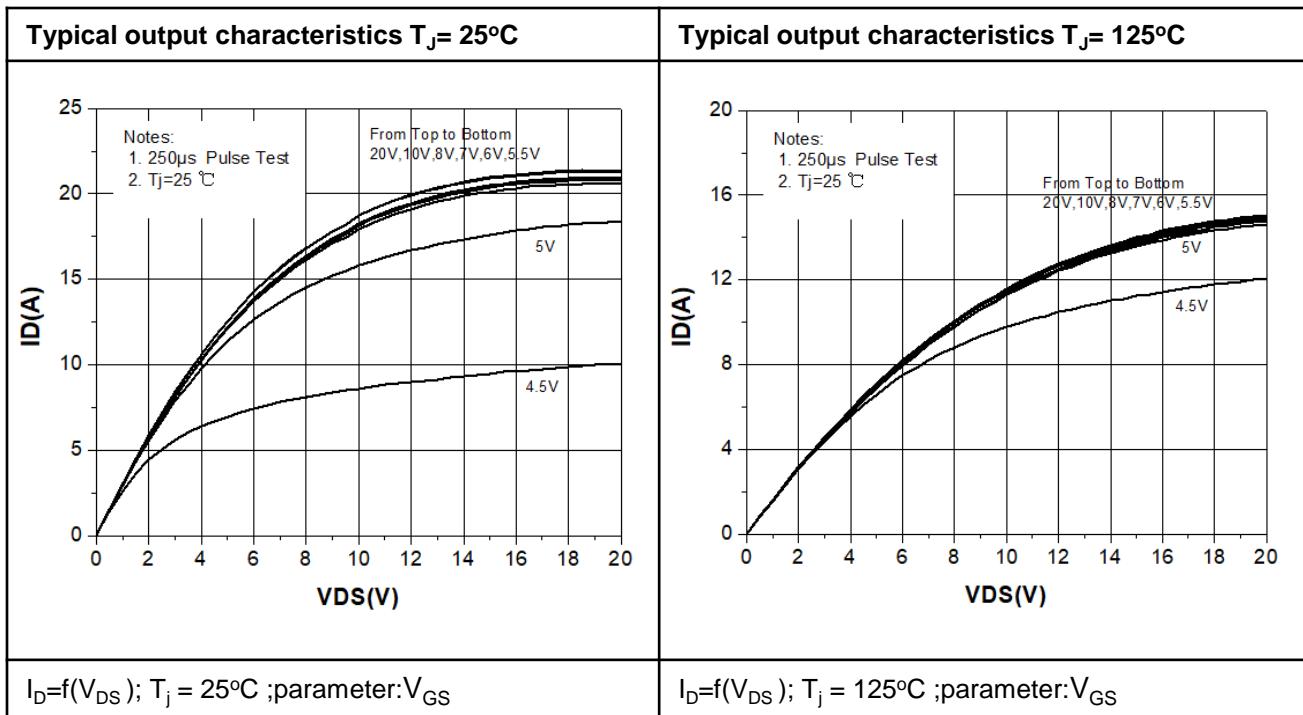
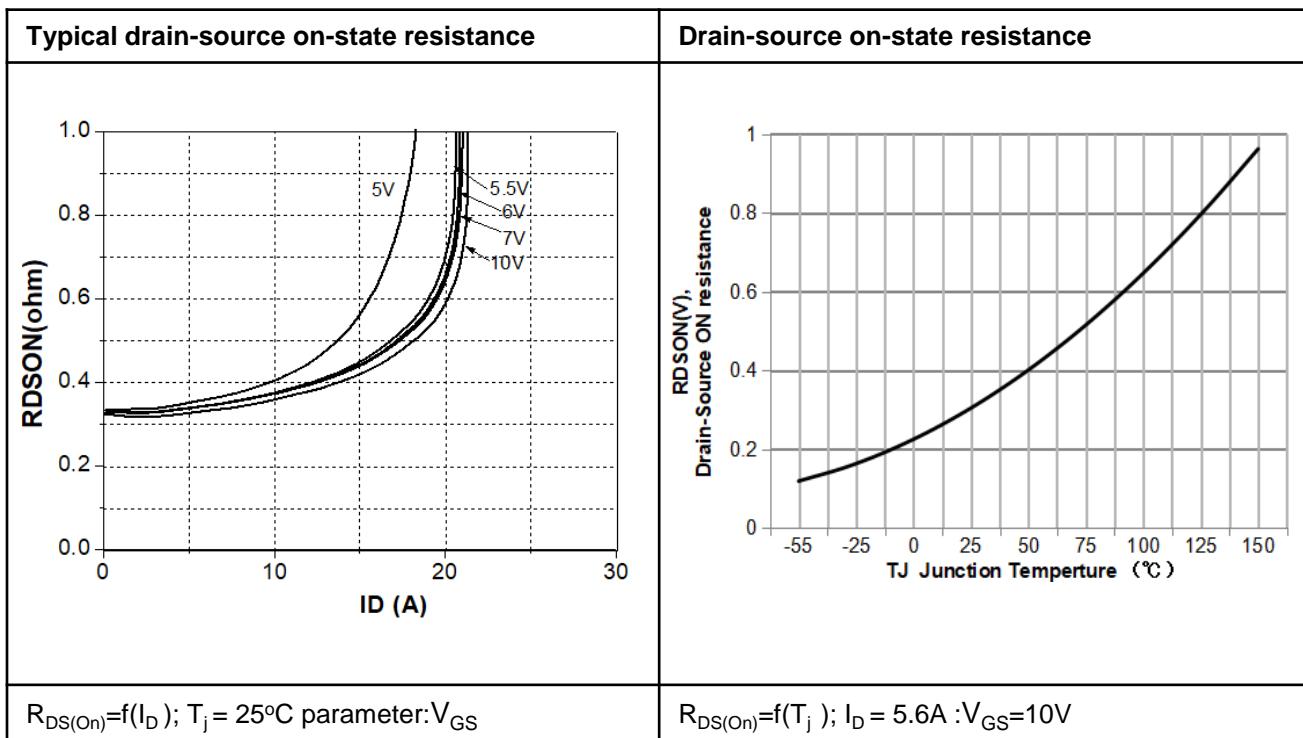
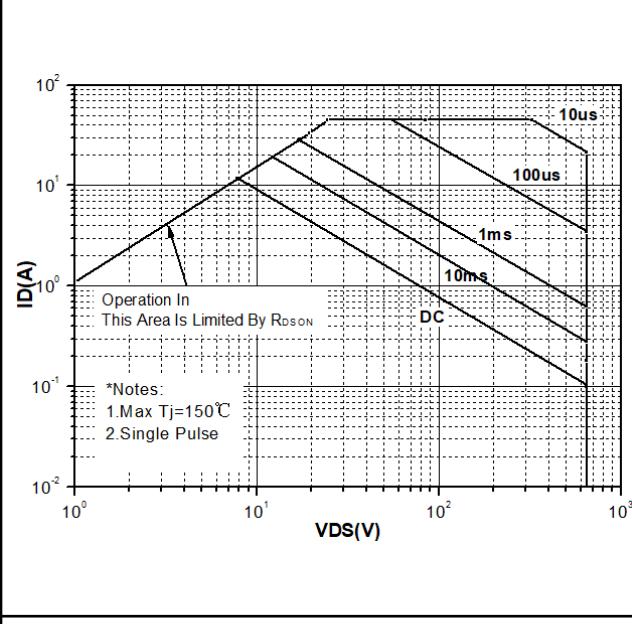
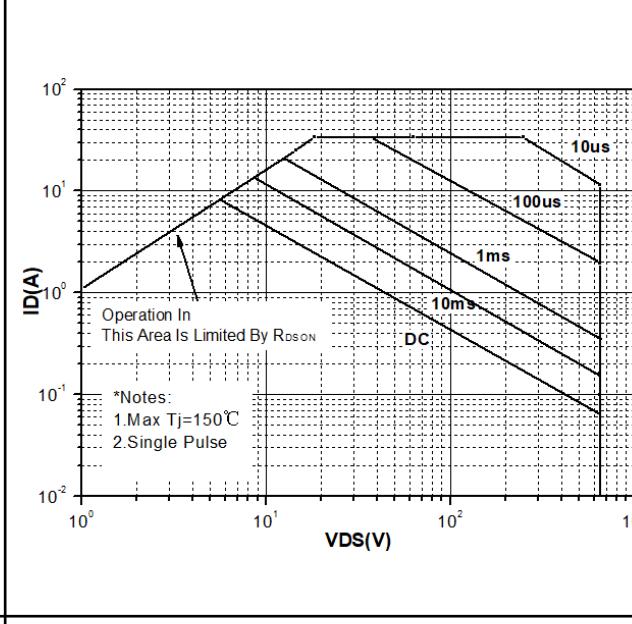
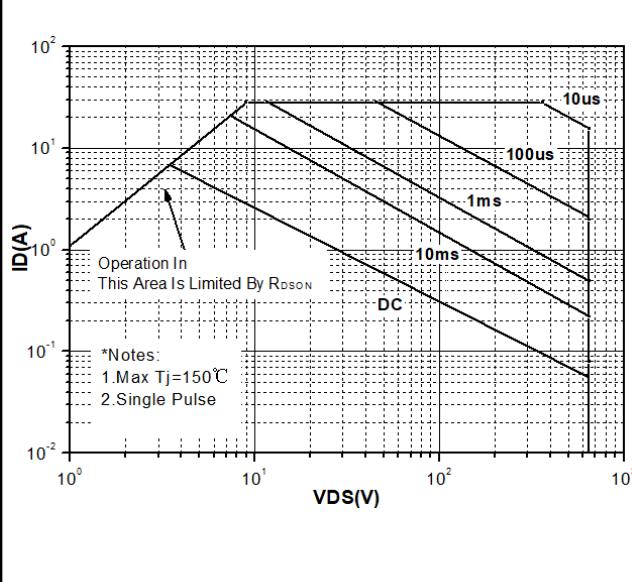
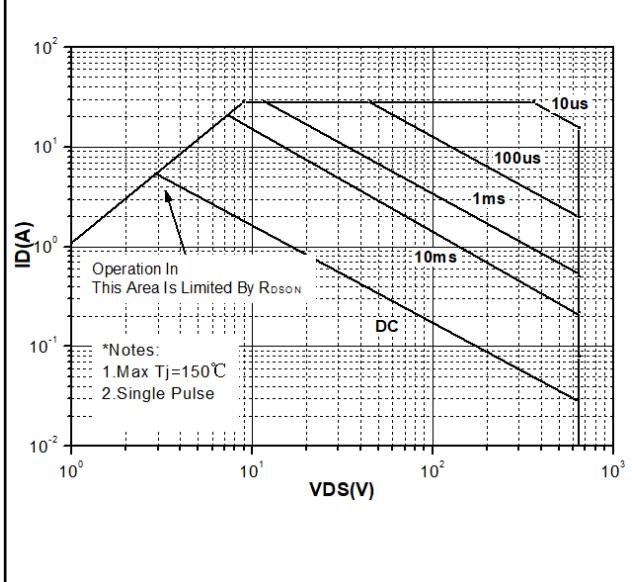
Table 9 Output Characteristics

Table 10 Drain Source Resistance


Table 12 Safe Operating Area

Safe operating area $T_C = 25^\circ\text{C}$ (TO220, TO263 & TO247)	Safe operating area $T_C = 80^\circ\text{C}$ (TO220, TO263 & TO247)
 <p>Notes: 1. Max $T_j=150^\circ\text{C}$ 2. Single Pulse</p>	 <p>Notes: 1. Max $T_j=150^\circ\text{C}$ 2. Single Pulse</p>

 $I_D=f(V_{DS})$; $T_C = 25^\circ\text{C}$; $D=0$; parameter: t_P
 $I_D=f(V_{DS})$; $T_C = 80^\circ\text{C}$; $D=0$; parameter: t_P

Safe operating area $T_C = 25^\circ\text{C}$ (TO220F)	Safe operating area $T_C = 80^\circ\text{C}$ (TO220F)
 <p>Notes: 1. Max $T_j=150^\circ\text{C}$ 2. Single Pulse</p>	 <p>Notes: 1. Max $T_j=150^\circ\text{C}$ 2. Single Pulse</p>

 $I_D=f(V_{DS})$; $T_C = 25^\circ\text{C}$; $D=0$; parameter: t_P
 $I_D=f(V_{DS})$; $T_C = 80^\circ\text{C}$; $D=0$; parameter: t_P

Table 12 Capacitances and Gate Charge

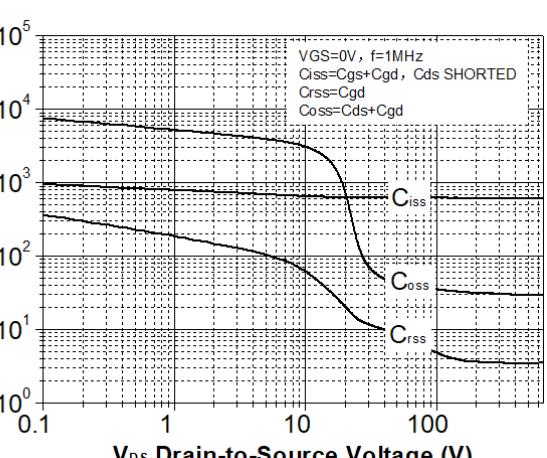
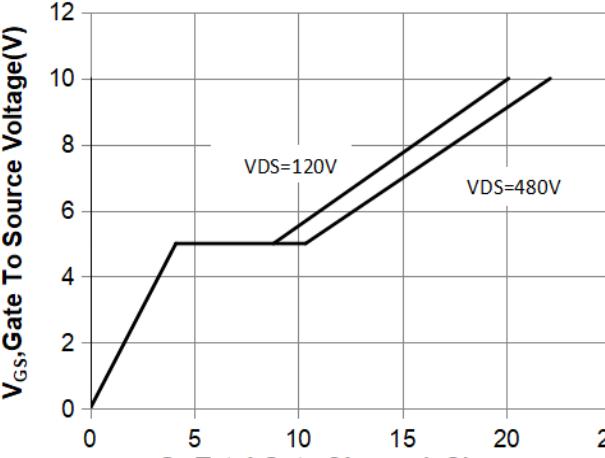
Typical Capacitances	Typical Gate charge
	
V _{gs} =0v, Freq.= 1MHz	I _D =f(Q _{gate}); I _D = 7.1A pulsed; parameter: V _{DD}

Table 13 Diode Characteristics and Avalanche Energy

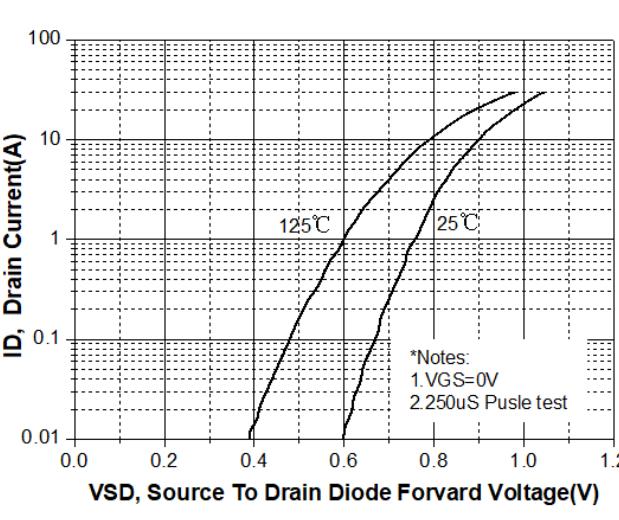
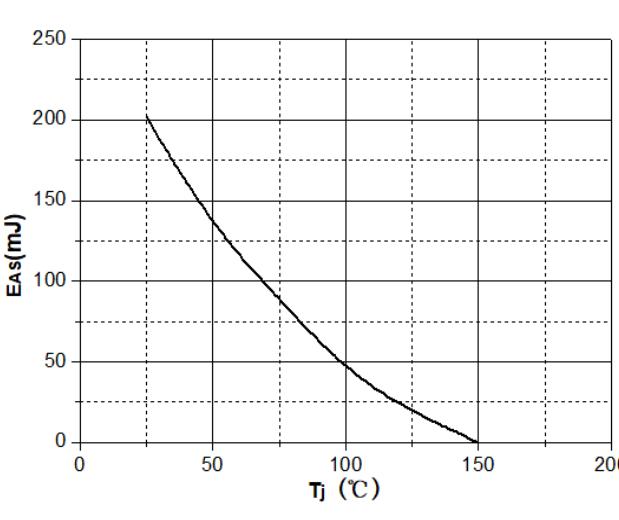
Forward characteristics of reverse diode	Avalanche energy
	
I _F =f(V _{SD}); parameter:T _j	E _{AS} =f(T _j); I _D = 1.8A ; V _{DD} = 50V

Table 16 Breakdown Voltage and Transfer Characteristics

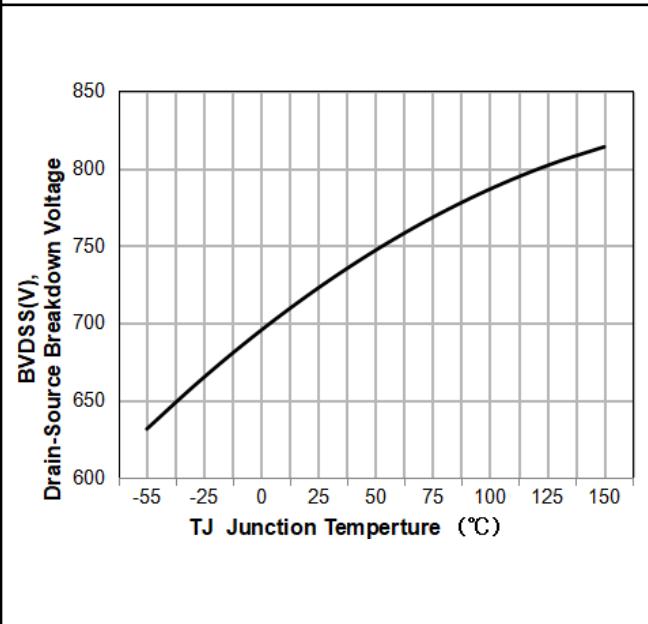
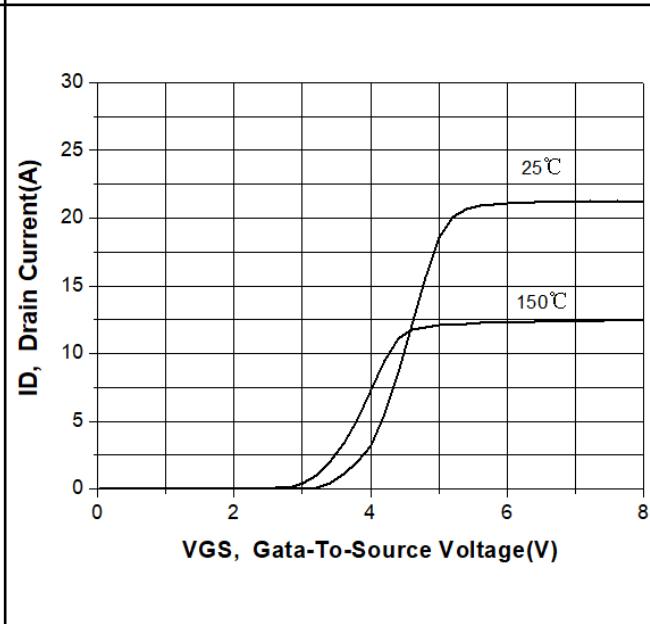
Drain-source breakdown voltage	Transfer Characteristics
 <p>This graph shows the drain-source breakdown voltage (V_{BDSS}) in Volts on the y-axis (ranging from 600 to 850) versus junction temperature (T_j) in degrees Celsius on the x-axis (ranging from -55 to 150). The curve starts at approximately 630V at -55°C and increases monotonically, reaching about 815V at 150°C.</p>	 <p>This graph shows drain current (I_D) in Amperes on the y-axis (ranging from 0 to 30) versus gate-to-source voltage (V_{GS}) in Volts on the x-axis (ranging from 0 to 8). Two curves are plotted: one for 25°C and one for 150°C. Both curves show a sharp increase in current starting around $V_{GS} = 3V$. The 25°C curve reaches a higher current of approximately 22A at $V_{GS} = 6V$, while the 150°C curve reaches approximately 12A at the same voltage.</p>
$V_{BR(DSS)} = f(T_j)$; $I_D = 0.25\text{mA}$	$I_D = f(V_{GS})$; $ V_{DS} > 2 I_D R_{DS(On)\max}$; parameter: T_j

Table 15 Diode Recovery Characteristic

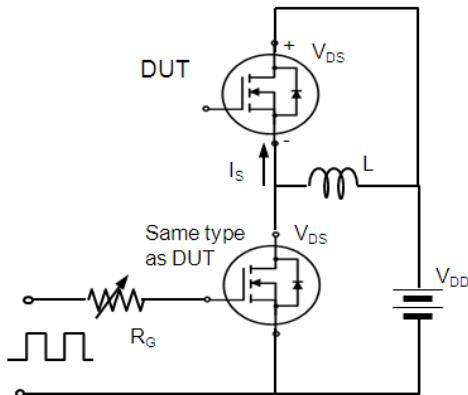
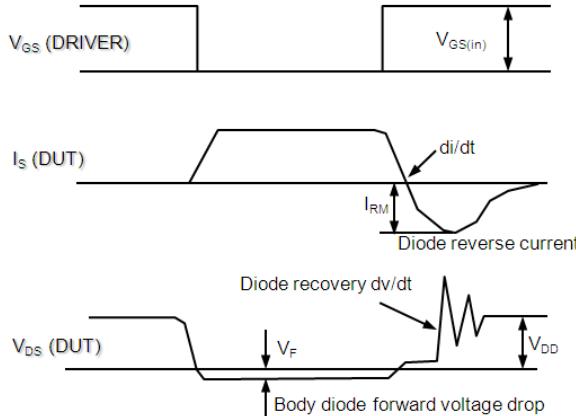
Test Circuit For Diode Recovery	Test Waveform For Diode Recovery
 <p>*. $\frac{dv}{dt}$ controlled by R_G *. I_S controlled by pulse period</p>	

Table 16 Switching Time Characteristic

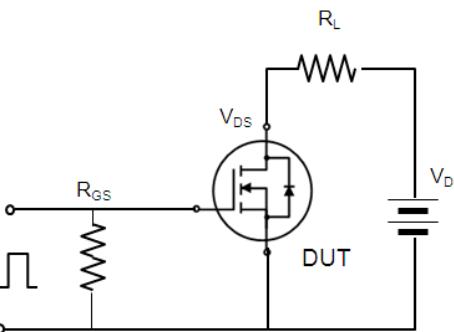
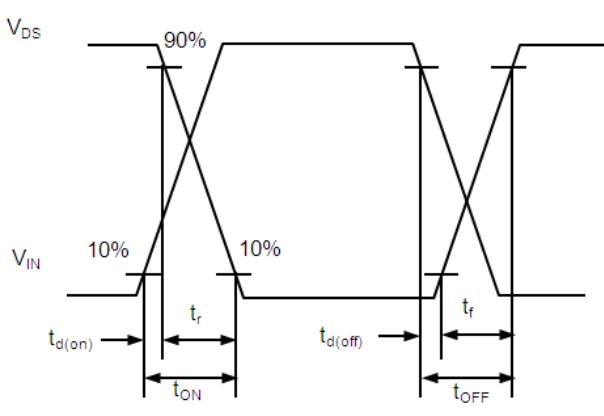
Test Circuit for Switching Time	Test Waveform for Switching Time
	

Table 17 Gate Charge Characteristic

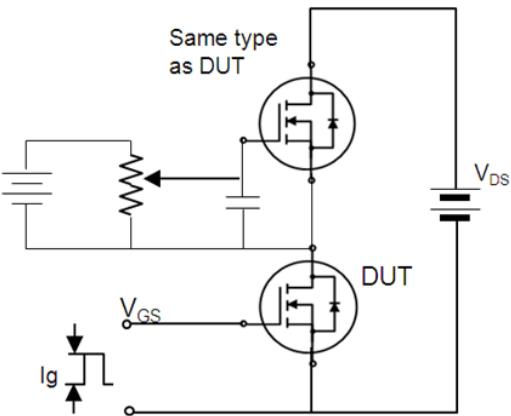
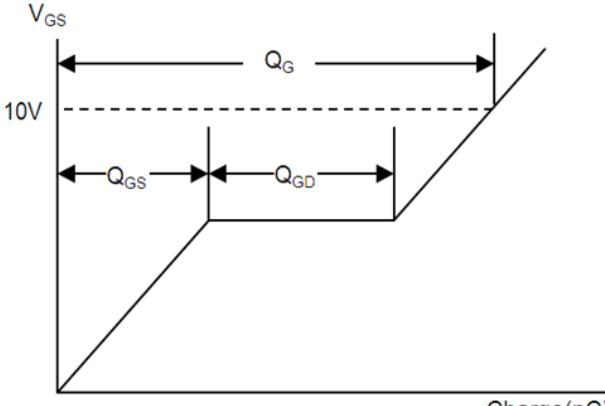
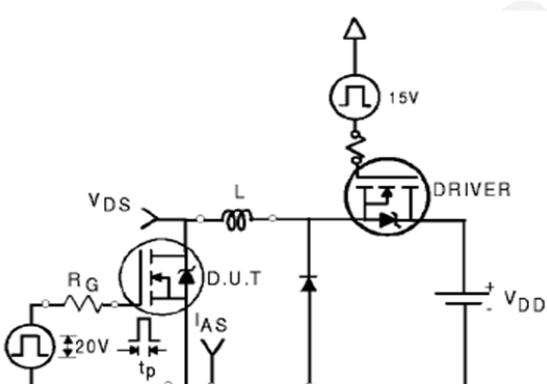
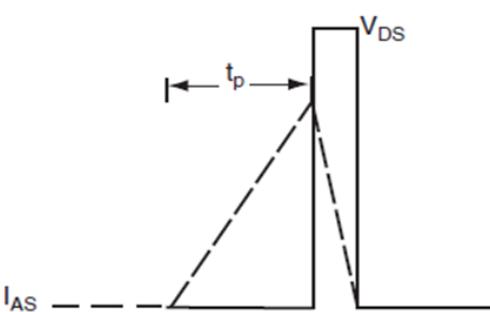
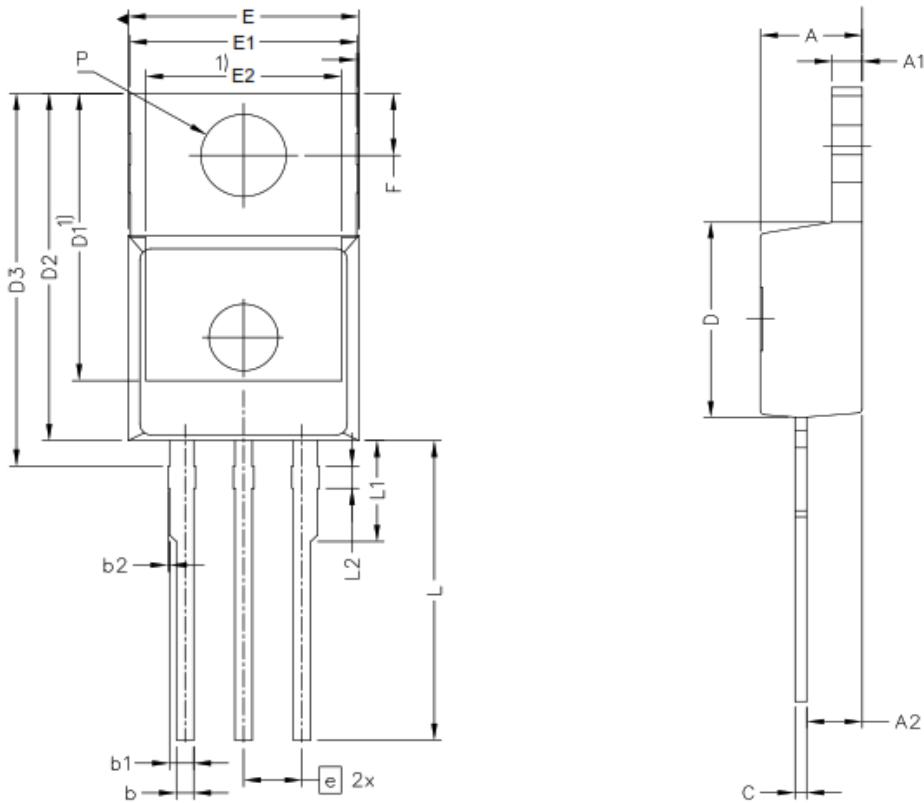
Test Circuit For Gate Charge	Test Waveform For Gate Charge
	

Table 18 Unclamped Inductive Characteristic

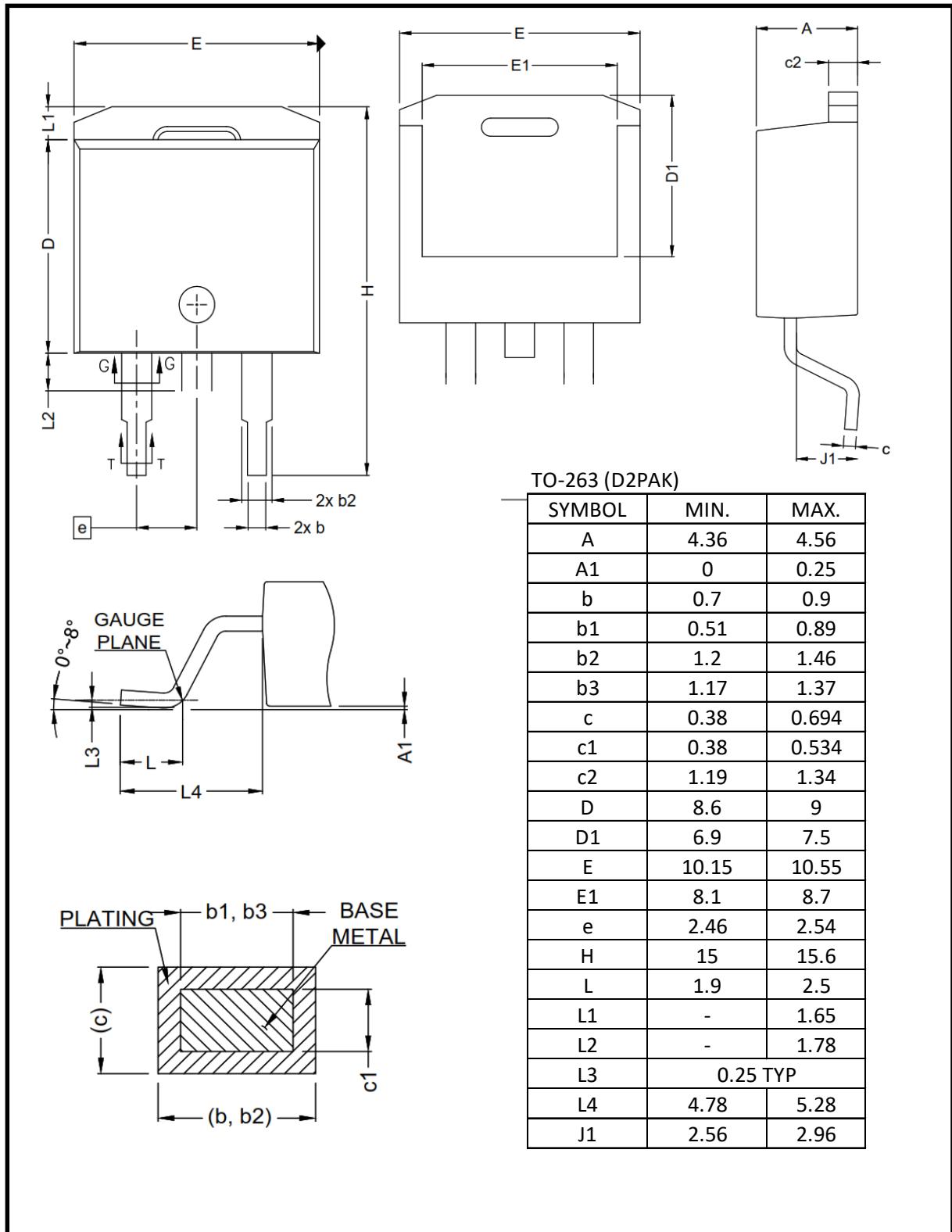
Test Circuit For Unclamped Inductive	Test Waveform For Unclamped Inductive
	$E_{AS} = \frac{1}{2} L I_{AS}^2$ 

4a) TO-220

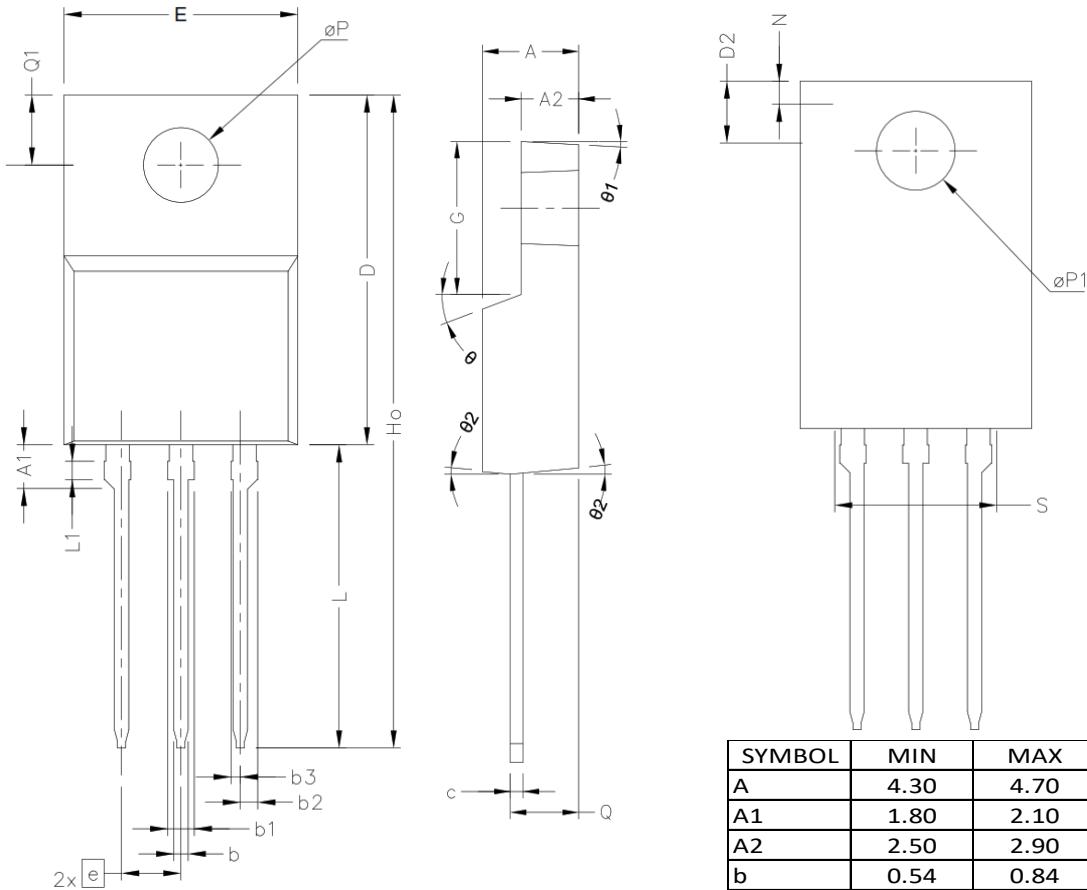


TO-220 3L

SYMBOL	MIN	MAX
A	4.20	4.60
A1	1.20	1.40
A2	2.20	2.60
b	0.65	0.85
b1	0.95	1.15
b2		0.15
C	0.40	0.60
D	9.05	9.45
D1	12.95	
D2	15.35	15.95
D3	16.50	17.10
E	9.80	10.20
E1	9.70	10.10
E2	8.50	
e	2.46	2.54
F	2.60	3.00
L	13.00	14.00
L1	4.35	4.75
L2	0.90	1.10
P	3.55	3.85

4b) TO-263


4C) TO-220 FullPak



SYMBOL	MIN	MAX
A	4.30	4.70
A1	1.80	2.10
A2	2.50	2.90
b	0.54	0.84
b1	0.99	1.29
b2	0.56	0.93
b3	0.24	0.55
c	0.49	0.79
D	14.70	15.30
D2	2.66	
e	2.29	2.79
E	9.70	10.30
G	6.70	7.10
H _o	28.00	
L	12.50	13.50
L1	0.70	0.90
N		2.86
ϕP	3.05	3.40
$\phi P1$		3.40
Q	3.10	3.30
Q1	2.70	3.30
S		7.00
$\Theta 1$		3 deg.
$\Theta 2$		5 deg.

Revision History

Revision	Release Date	Comments
1.0	1-Dec 2017	Preliminary Datasheet Draft
2.0	2-Jan 2019	Characterization and enhancements

Resources

www.d3semi.com

Patents, Copyrights and Trademarks

U.S. and Foreign Patents Pending.

The following are trademarks and service marks owned by D3 Semiconductor:

D3 Semiconductor®, "Flying D"  , +FET, Defining Precision Power . All Trademarks are property of their respective  rs. © D3 Semiconductor 2016. All rights reserved

Legal Disclaimer

The information in this document is provided solely regarding D3 Semiconductor ("D3") products. The information is not a guarantee of performance or characteristics. D3 Semiconductor reserves the right to modify, change, amend, improve or make corrections to this document, and its products, at any time and its sole discretion without prior written consent or notice. No license to any intellectual property rights is granted or implied under this document. D3 Semiconductor disclaims warranties and liabilities of any kind including non-infringement of intellectual property rights of any third party. D3 Semiconductor products may be used in applications such as automotive, military, aerospace, medical or other applications where failure or malfunction may result in personal injury, death or severe property or environmental damage only with express written approval from D3 Semiconductor. Sale of D3 Semiconductor products are subject to D3 Semiconductor's standard terms and conditions. Products not purchased through D3 Semiconductor's authorized distributors, agents or sales representatives are void of warranty.

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

[D3 Semiconductor](#):

[D3S0380N65E-U](#) [D3S0380N65B-U](#) [D3S380N65E-U](#) [D3S380N65B-U](#) [D3S380N65E-T](#) [D3S380N65F-U](#)